

# **Preliminary Results of Spatial Resolution Performances of Capacitive Sharing Large Pad Readout in Test Beam**

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**RD51 Collaboration, October 09, 2020**

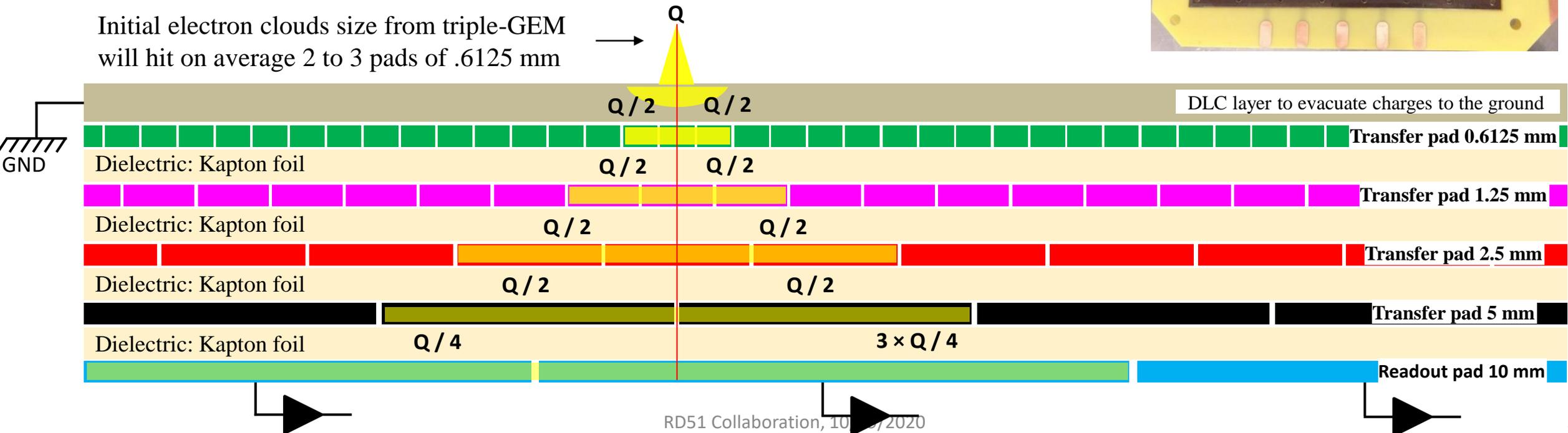
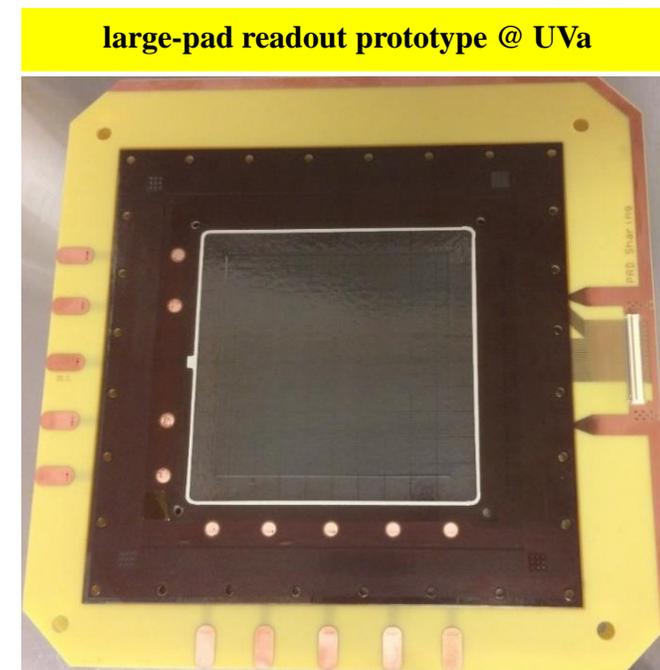
# Outline

- Principe of Capacitive-Sharing Large-Pads Readout PCB
- Potential Applications for EIC MPGD-based Tracking & PID Detector Options
- First Prototype & Preliminary Test Beam Results
- Further R&D on Large-Pads Capacitive Readout

# Principle of Large Pads with Capacitive Sharing readout PCB

## Principle of capacitive-sharing large-pad Readout

- ❑ Vertical stack of pads layers  $\Rightarrow$  Transfer of initial charge from MPGD by **capacitive coupling**
- ❑ Space arrangement of the pads and doubling pad size from one layer to the one below allow:
  - $\Rightarrow$  Preservation of the spatial resolution (Goal  $\Rightarrow 100 \mu\text{m}$  for  $1 \text{ cm}^2$  pad readout)
  - $\Rightarrow$  significant reduction of number of electronic channels to be read out
- ❑ Low cost and flexible readout technology
  - $\Rightarrow$  Suitable to a variety of applications related to EIC detector R&D programs



## Several MPGD technologies under consideration for EIC tracking and PID

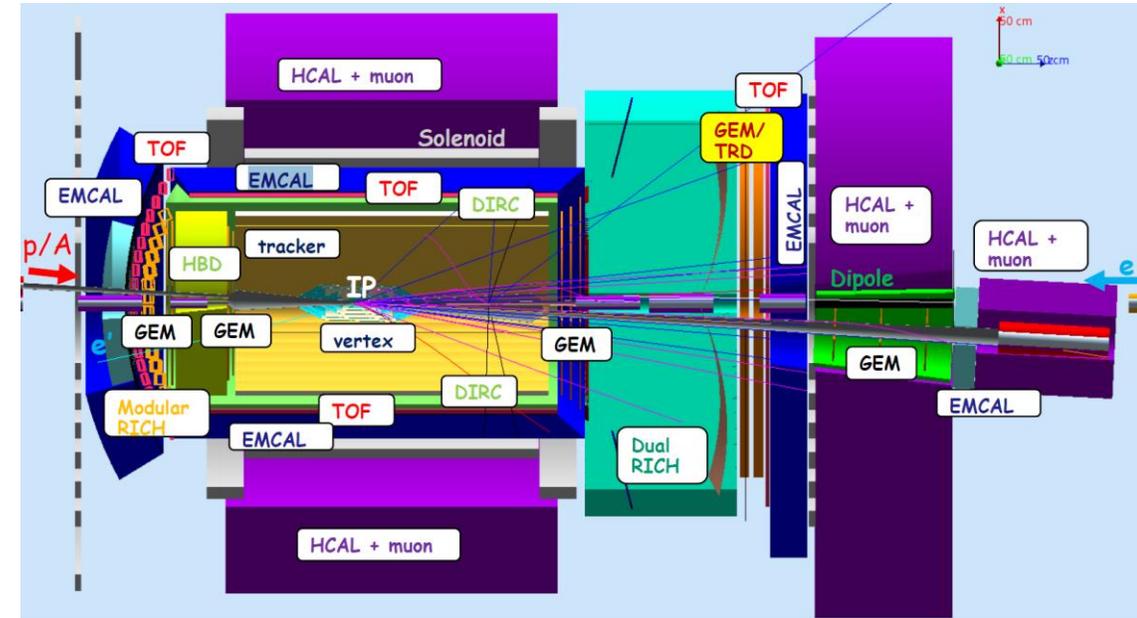
### Tracking detectors options with MPGDs

- ⇒ TPC for central tracking with GEM or hybrid MPGDs readout planes
- ⇒ Multilayer Cylindrical MPGDs for the EIC barrel tracker
- ⇒ Planar MPGD disc layers in both electron and hadron end caps

### PID options with MPGDs

- ⇒ Hybrid THGEMs & Micromegas for high momentum RICH in hadron end cap
- ⇒ Short length GEM-RICH for high momentum RICH in hadron end cap
- ⇒ GEM-TRD (Transition Radiation Detector) ⇒ both end caps

EIC Detector Concept (JLEIC) Design



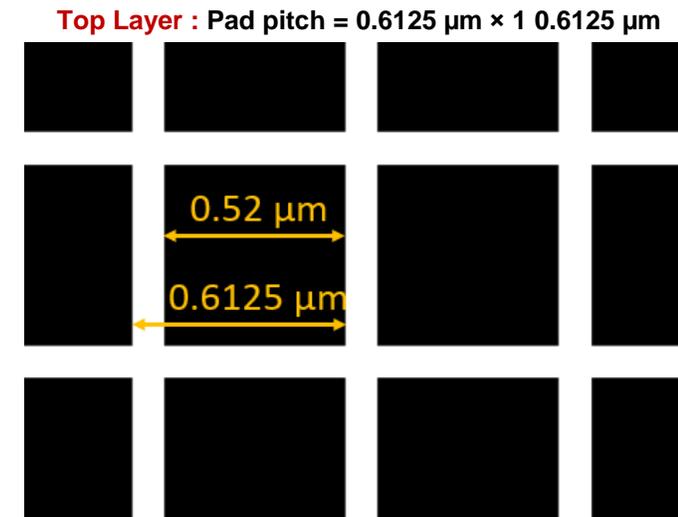
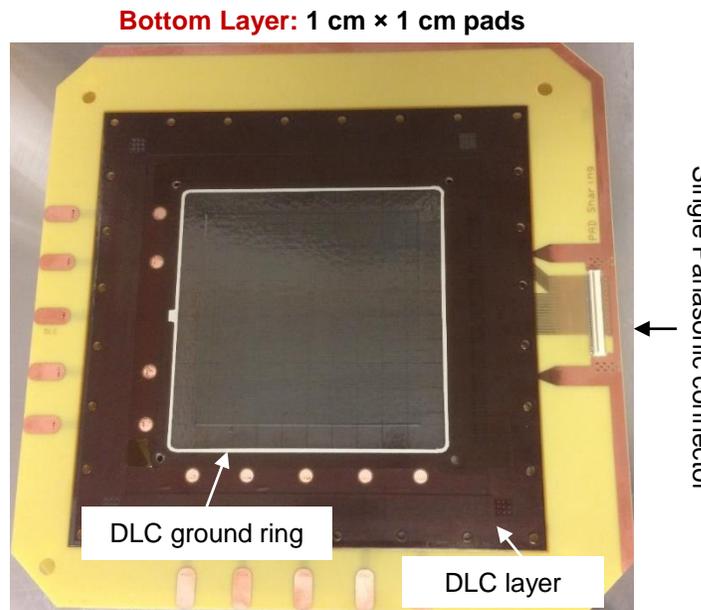
## Why is large pads with capacitive sharing readout is an option for all MPGD technologies and applications cited above:

- Relatively low particle flux rate expected at the EIC tracking detectors in all eta regions (compared to LHC or fixed target experiment at JLab)
  - ⇒ Don't have to worry about pile-up and multiple hit events for trackers
- Flexibility of the readout concept: One can design the large-pad readout PCB parameters to address specific detector technology and application
  - ⇒ i.e. pad size for the top and / or bottom pad layers, numbers of layers, pad geometry and thickness ... can be detector specific
- The large pads with capacitive sharing readout technique is pretty straight forward: don't anticipate an extensive R&D program to fully validate the concept
  - ⇒ Cost effective solution with low production risk

# GEM prototype with Capacitive Sharing 1 cm × 1 cm Pad Readout

## 5-layers capacitive-sharing pad readout prototype:

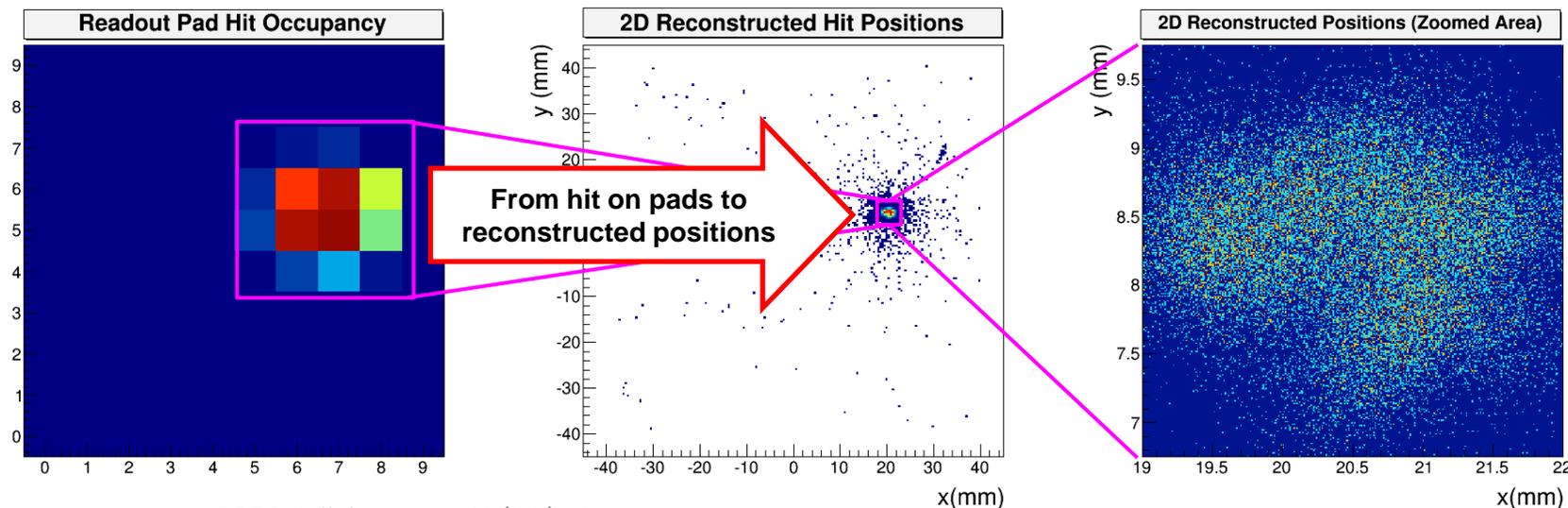
- ❑ **Top pad layer** (define basic resolution performances):
  - ❑ Pitch: 0.6125 mm × 0.6125 mm (**0.1 mm inter-pad**)
  - ❑ Pad size: 0.52 mm × 0.52 mm
- ❑ **Bottom pad layer** (readout pad):
  - ❑ Pitch: 10 mm × 10 mm (**0.1 mm inter-pad**)
  - ❑ Pad size: 9.9 mm × 9.9 mm
- ❑ DLC layer with surface resistivity 10 - 20 MΩ
- ❑ 100 readout Pads



## GEM prototype with capacitive-sharing pad in x-ray

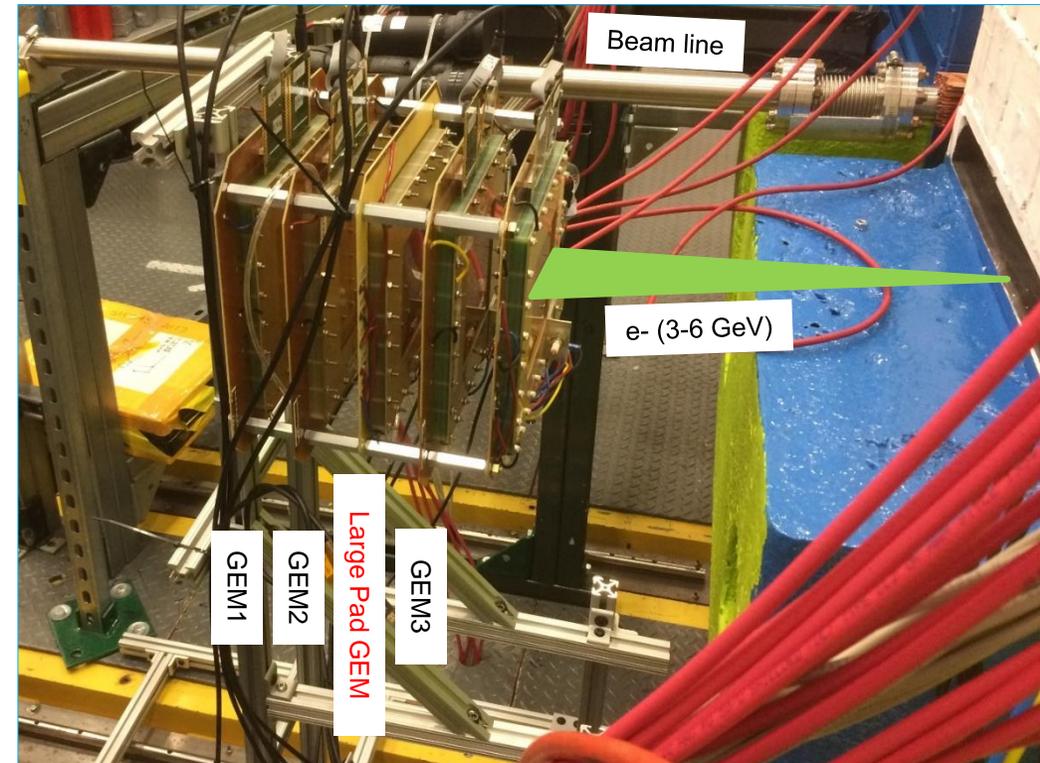
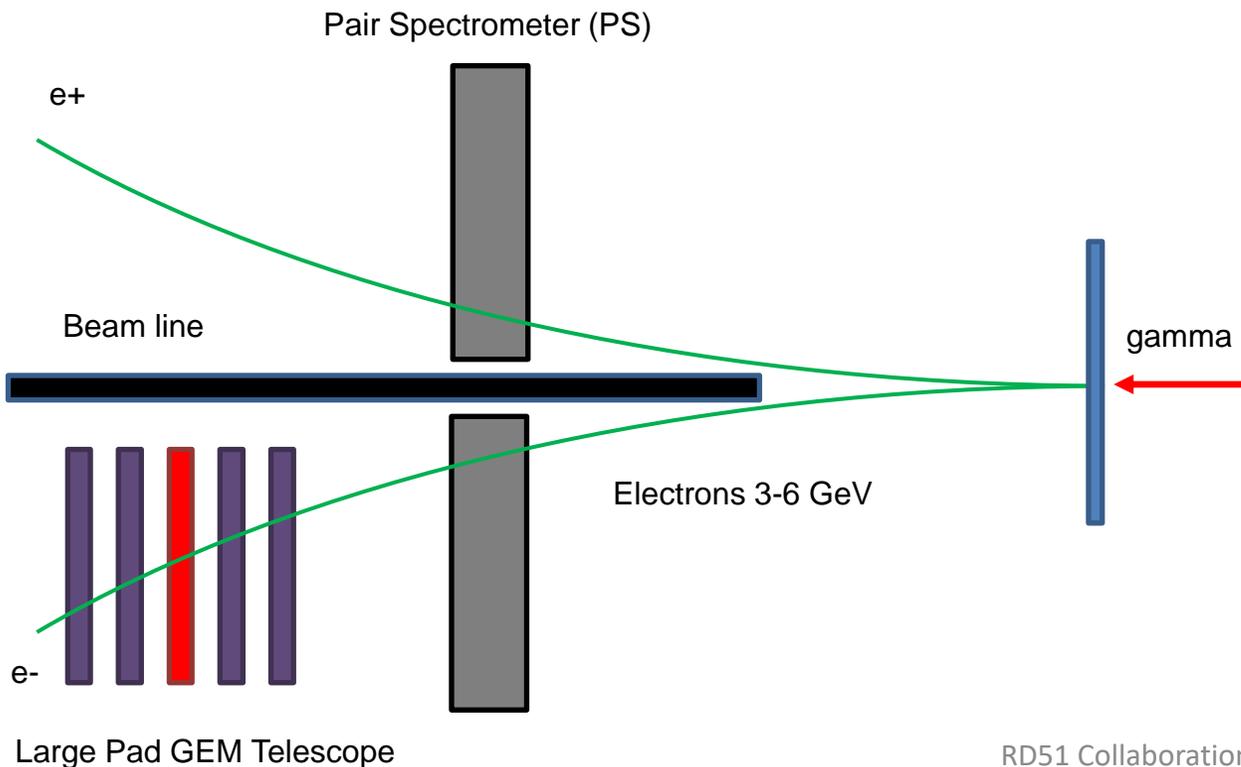


## Pad Occupancy & 2D hit reconstruction with x-ray



## Parasitic setup in the electron arm of Hall D Pair Spectrometer (PS) @ JLab.

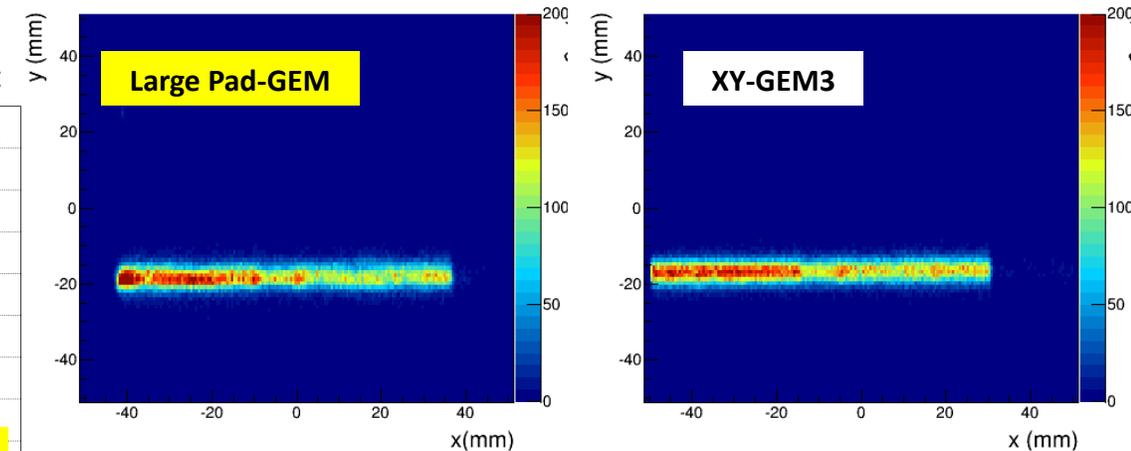
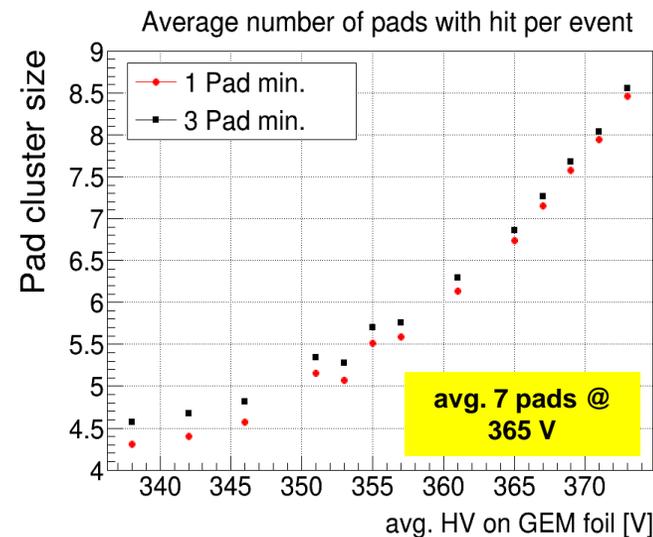
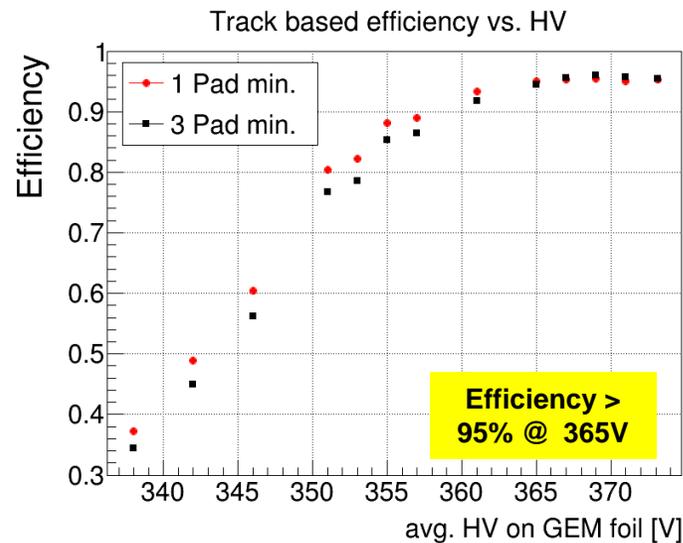
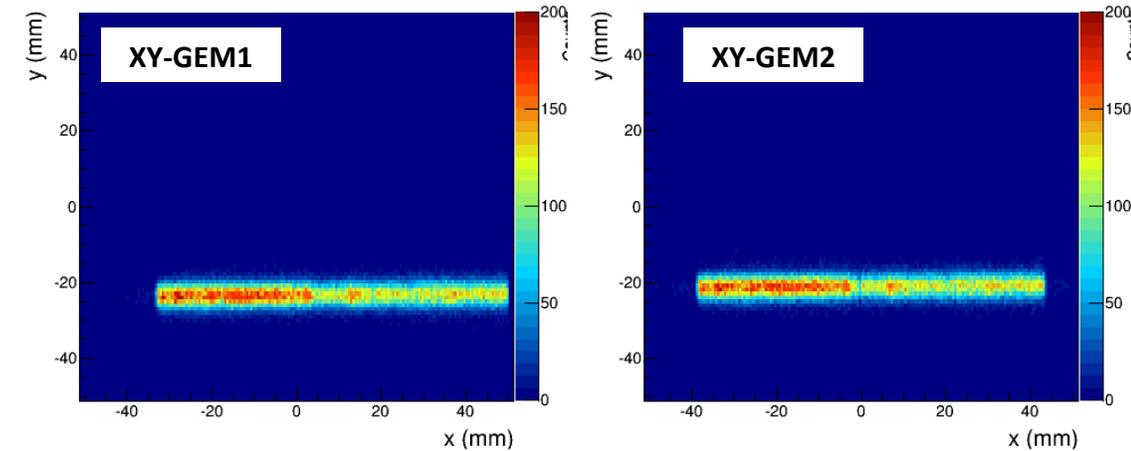
- ❑ Clean electron beam (3 to 6 GeV), incoming angle up to 8 degree
- ❑ Large Pad GEM + 3 small X-Y CERN standard triple-GEM for tracking
- ❑ APV25-SRS readout (DATE + AmoreSRS), trigger rate limited to 400Hz
- ❑ Large volume of data for HV scan and for spatial resolution - Mid-September 2020



## Large Pad GEM detector performances:

- ❑ HV scan from with 340 V to 375V to GEM foils
  - ❑ 372V is the average voltage on GEM foil for a COMPASS GEM @ 4100 V
- ❑ Track based efficiency using 2 XY trackers as reference
- ❑ Full efficiency above 365V
  - ❑ 1 Pad min.: all pads above  $2\sigma$  pedestal cut considered in analysis
  - ❑ 3 Pad min.: We only consider event with at least 3 pads above  $2\sigma$  pedestal cut
    - ❑ At full efficiency, at least 3 pads record hit above pedestal for all events
- ❑ Average number of pads above  $2\sigma$  pedestal cut
  - ❑ > 7 pads on average with hit at a GEM voltage > 365V

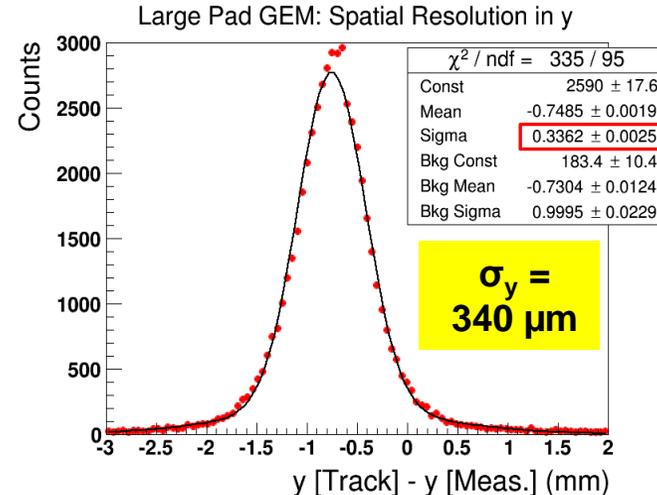
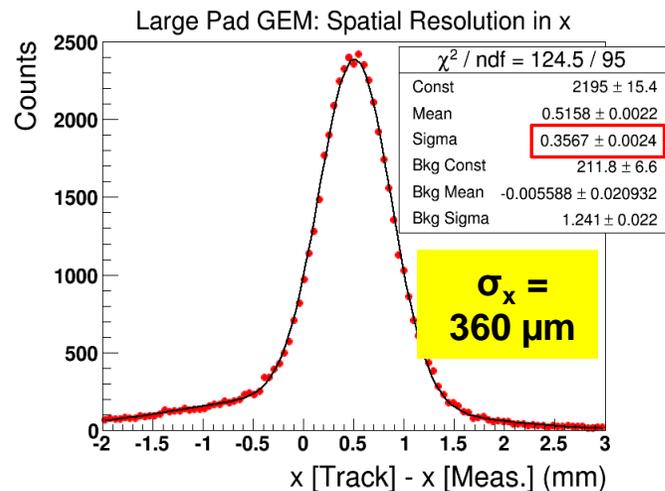
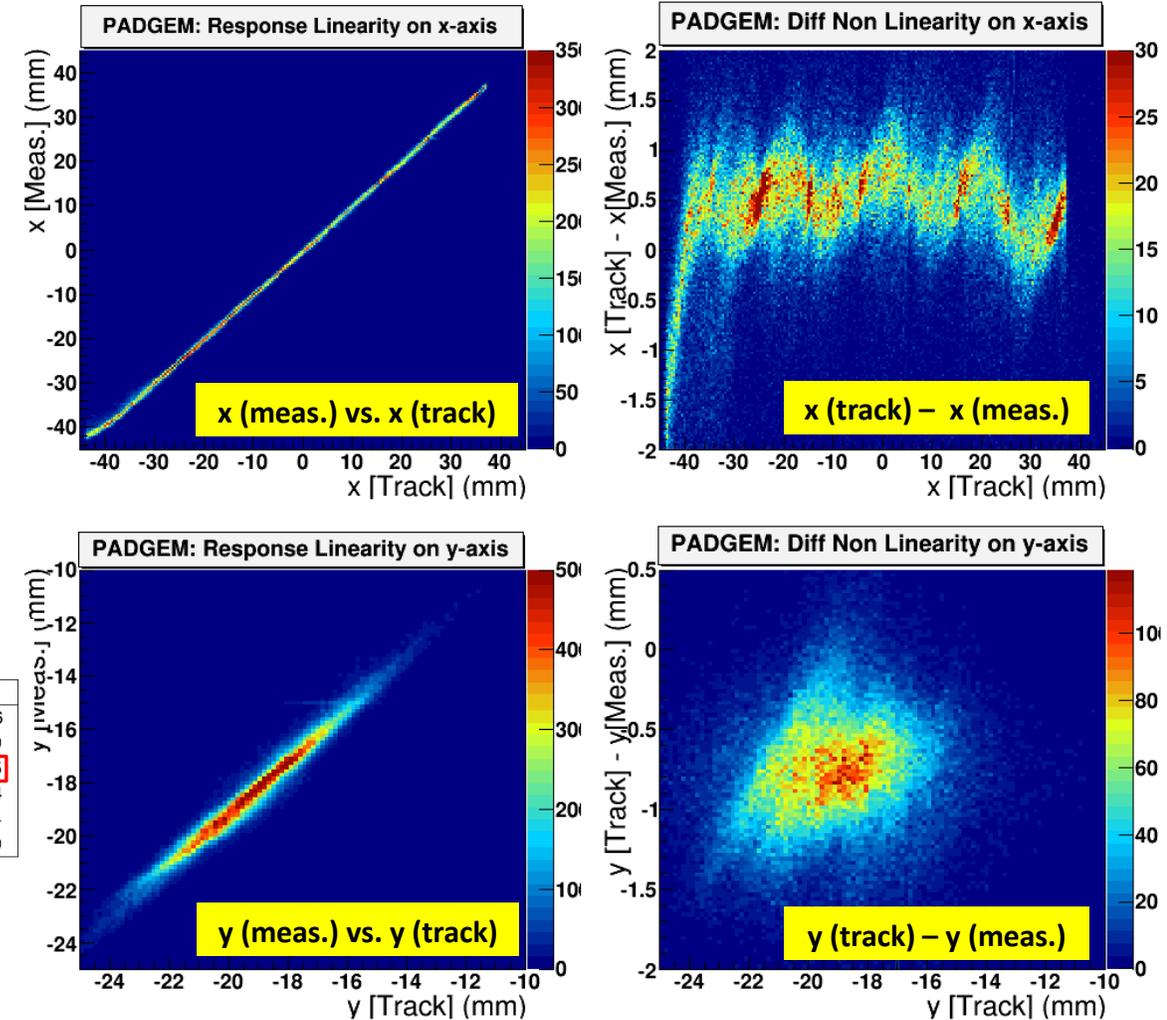
## 2D hit map of the reconstructed electron beam profile



## Spatial resolution studies:

- ❑ Very preliminary analysis:
  - ❑ Track was based on straight line from only 2 XY trackers (GEM1 & GEM3)
  - ❑ No alignment and offset correction performed yet
- ❑ Good response linearity of the chamber
  - ❑ Strong correlation between expected and measured positions
  - ❑ Non linearity pattern (DNL): could be parametrized as correction to the position
- ❑ Extracted resolution from residual width  $\sim 350 \mu\text{m}$  in both x and y direction
  - ❑ This is before any correction from alignment and track fit error
- ❑ Analysis is still on going and we expect some improvement of resolution performances
  - ❑ First results are very encouraging and provide clear direction on where the improvement is going to come from

## Pad GEM: Response linearity



# How to achieve the goal of 100 $\mu\text{m}$ resolution with 1 cm $\times$ 1cm pad R/O?

## 4 areas where we see room for improvement of the spatial resolution performance

### 1. Minimize the inter-pad gap between pads

- This is even more crucial for first pad layers where the pad size is small
- In our prototype the ratio pad size / pitch for the first pad layer is 17%  $\Rightarrow$  meaning 17 % of charges are not collected but most importantly, this affect the charge sharing between adjacent pads
- When this propagate through 5 layers, the charge sharing distortion becomes significant
- We plan to study the effect of inter pad gap on the resolution with a prototype with 4 different gap from 100  $\mu\text{m}$  to 40  $\mu\text{m}$

### 2. Optimization of the min pad size:

- With this concept of capacitive charge sharing, the parameters of the top pad layers are crucial for the resolution performances of the R/O
- We plan to study the impact of different top layer pad size on the spatial resolution

### 3. Minimization of the noise:

- Large pads = large capacitance noise to input of the FE pre amplifier. There are ideas to minimize the pad size of the readout layer while maintaining large pitch i.e. low channel count
- Also one need to optimize the traces to minimize their contribution to cross talk and noise
- We plan to study the impact of different top layer pad size on the spatial resolution

### 4. Offline correction for the non linearity response

- This is the next step of our analysis we expect big improvement (with maybe a factor 2) with the current not optimized prototype

# Extend the capacitive-sharing concept to 2D (and 4D XY-UV) R/O

## Capacitive sharing with strip R/O

- ❑ More interesting approach for large area detector
  - ❑ even less channel count and less pad layers to achieve high spatial resolution
  - ❑ Pad size of top layer to be adjusted to the type of MPGD amplification i.e. smaller pad (e.g. 200  $\mu\text{m}$ ) for uRWELL/micromegas, larger pad for GEM (e.g. 400  $\mu\text{m}$ )
  - ❑ Strip / pad-like strip R/O to ensure equal sharing and very good X/Y charge correlation
- ❑ Idea to expand this idea to a XY-UV readout board
  - ❑ Concept explored by D. Majka @ Yale U. with an XYU R/O to help solve **multiple hit ambiguity**
  - ❑ They reach 100  $\mu\text{m}$  resolution with 800 $\mu\text{m}$  pitch
  - ❑ With capacitive charge sharing, pitch can be increased by 2 or 4, with 4 coordinate capabilities XY-UV capability
  - ❑ This is also a solution for large area detector where multiple hit ambiguity is a concern

High Performances 3D - coordinates strips Readout:  
D. Majka, Yale U.

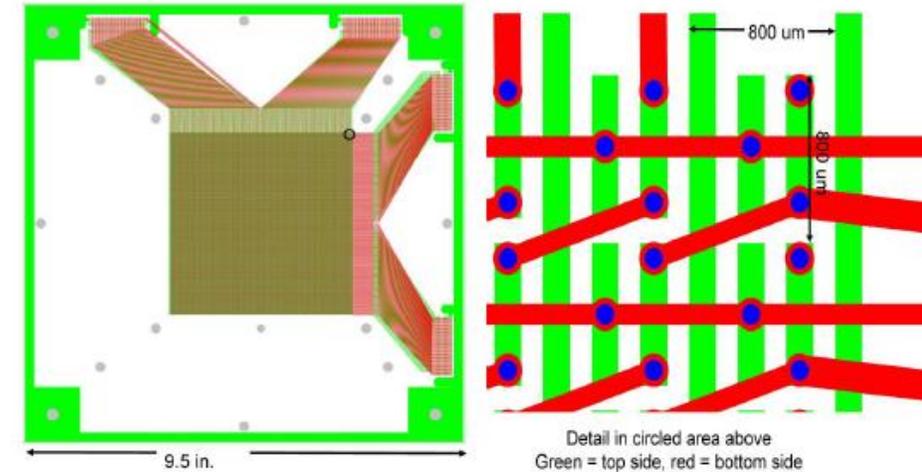
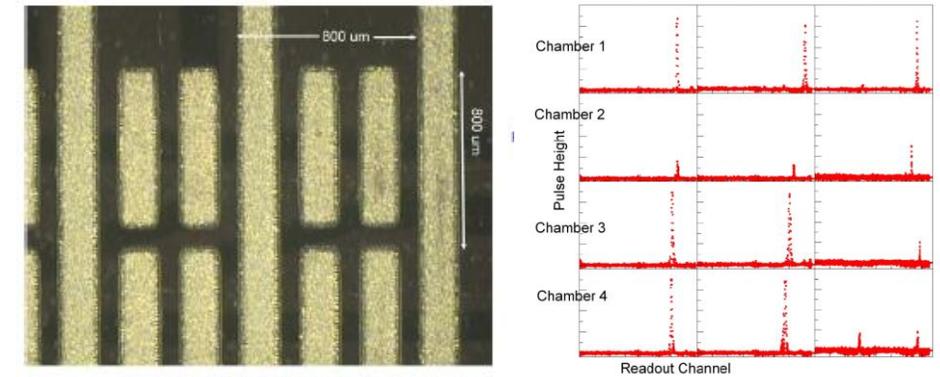
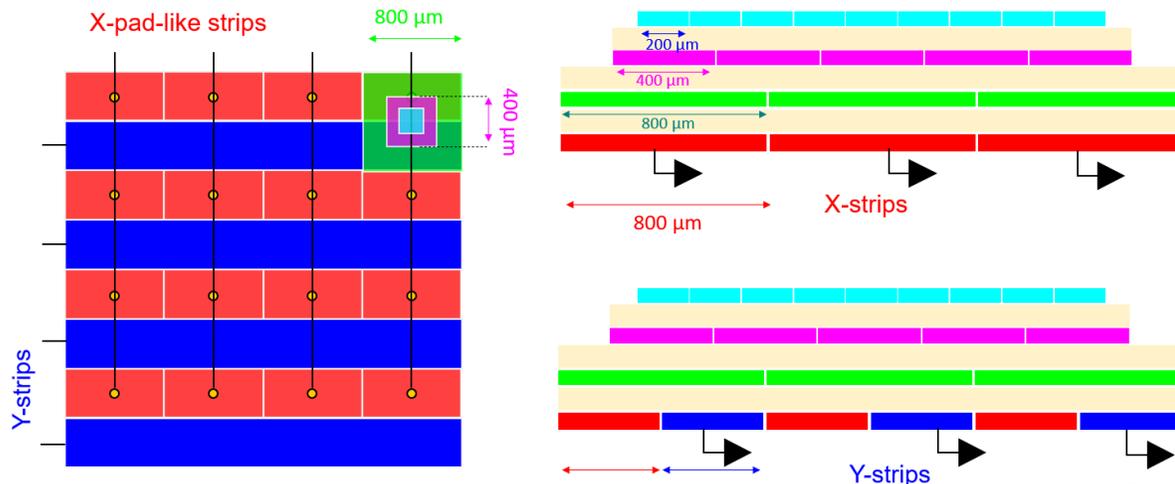


Figure 23: Layout of prototype 800  $\mu\text{m}$  pitch 3 coordinate readout board. Detail for circled area at upper right is shown at right and below.

## Capacitive-Sharing Large-Strip Readout: Low channel count X-Y strip readout



**Spatial resolution: 100  $\mu\text{m}$**

[https://wiki.bnl.gov/conferences/images/7/76/RD6-December-2013\\_Dehmelt-Hemmick.pdf](https://wiki.bnl.gov/conferences/images/7/76/RD6-December-2013_Dehmelt-Hemmick.pdf)

# Summary & To Do Next

## Preliminary results on spatial resolution performance of 1 cm x 1cm pad readout with capacitive sharing very encouraging

- Reach 350  $\mu\text{m}$  resolution with the first prototype before tracking error and offset and DNL corrections
- There is plenty room for improvement being implemented in the next generation of prototypes: Goal is to achieve a spatial resolution of 100  $\mu\text{m}$

## Some challenges specific to the capacitive charge sharing concept

- Minimizing the material thickness of such RO: Adding these layers considerably increases the thickness of the detector
  - Exploring the idea with Chromium pads to considerably reduce the overall thickness.
- Need to minimize the capacitance noise of the large size pads: In first order, spatial resolution not limited by the readout layer pad size
  - However large pad  $\Rightarrow$  large capacitance noise that will degrade signal to noise and therefore the spatial resolution performance

## The concept of capacitive charge sharing can be applied to a variety of readout pattern for MPGDs

- This can be applied to 2D (and 4-coordinates) strip readout for large area detector, XY-UV strips readout can help with multiple hit ambiguity
- This concept is flexible enough to be used for pad R/O for small chambers,

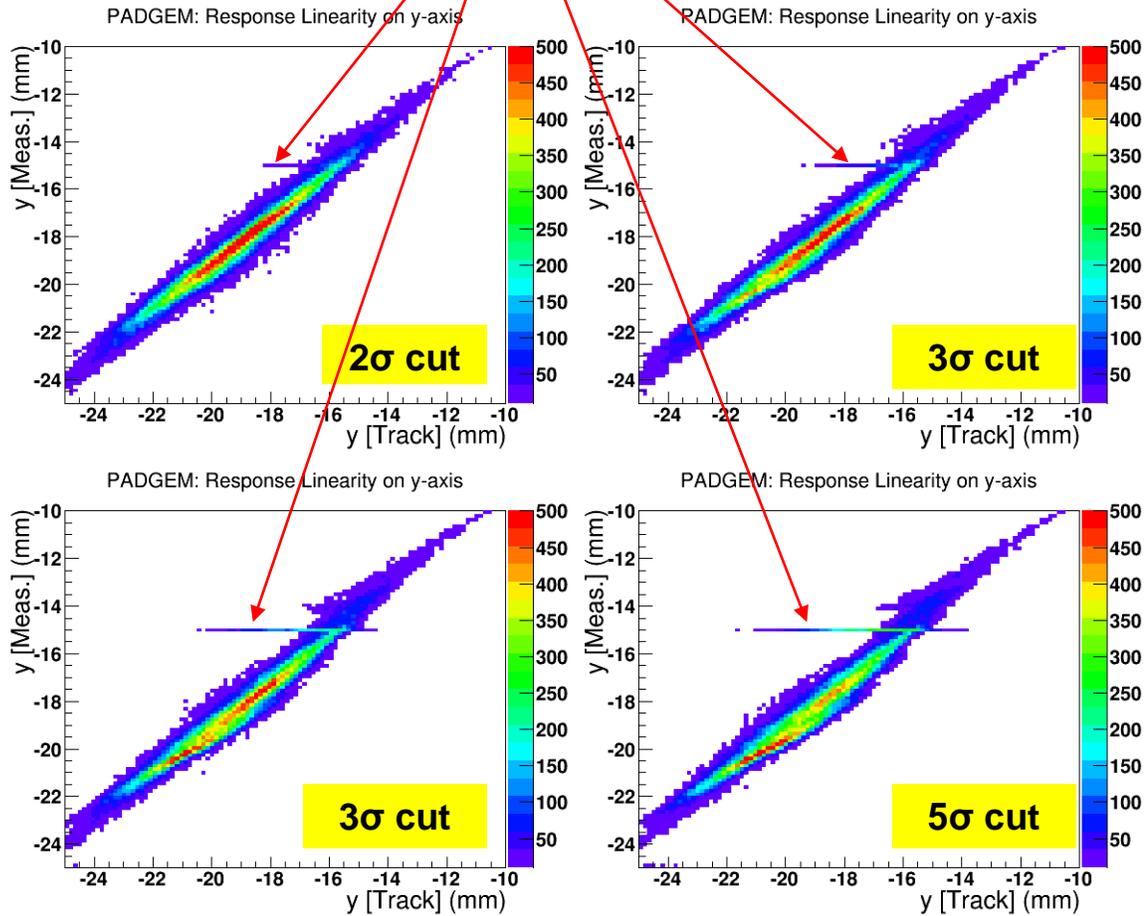
## Some obvious applications in our field of Tracking detector R&D

- Applying the same idea charge sharing through capacitive coupling to other type of readout geometry
- This concept will work perfectly well in moderate rate environment like for EIC tracking system

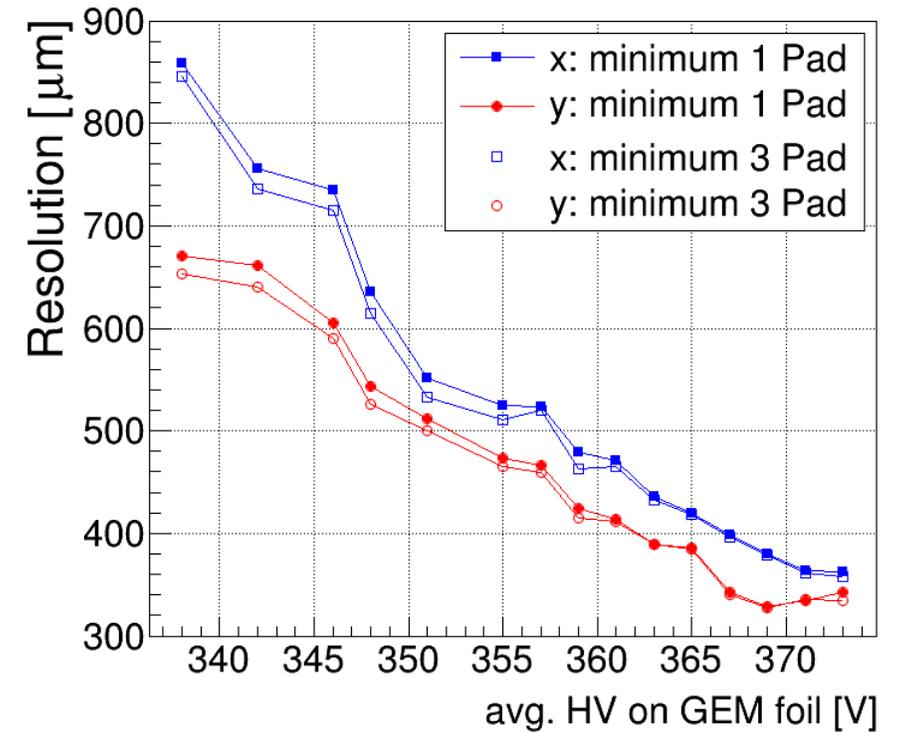
# BACKUP

# Preliminary Results with JLab Test Beam Data

Single pad event



### Spatial Resolution vs. HV

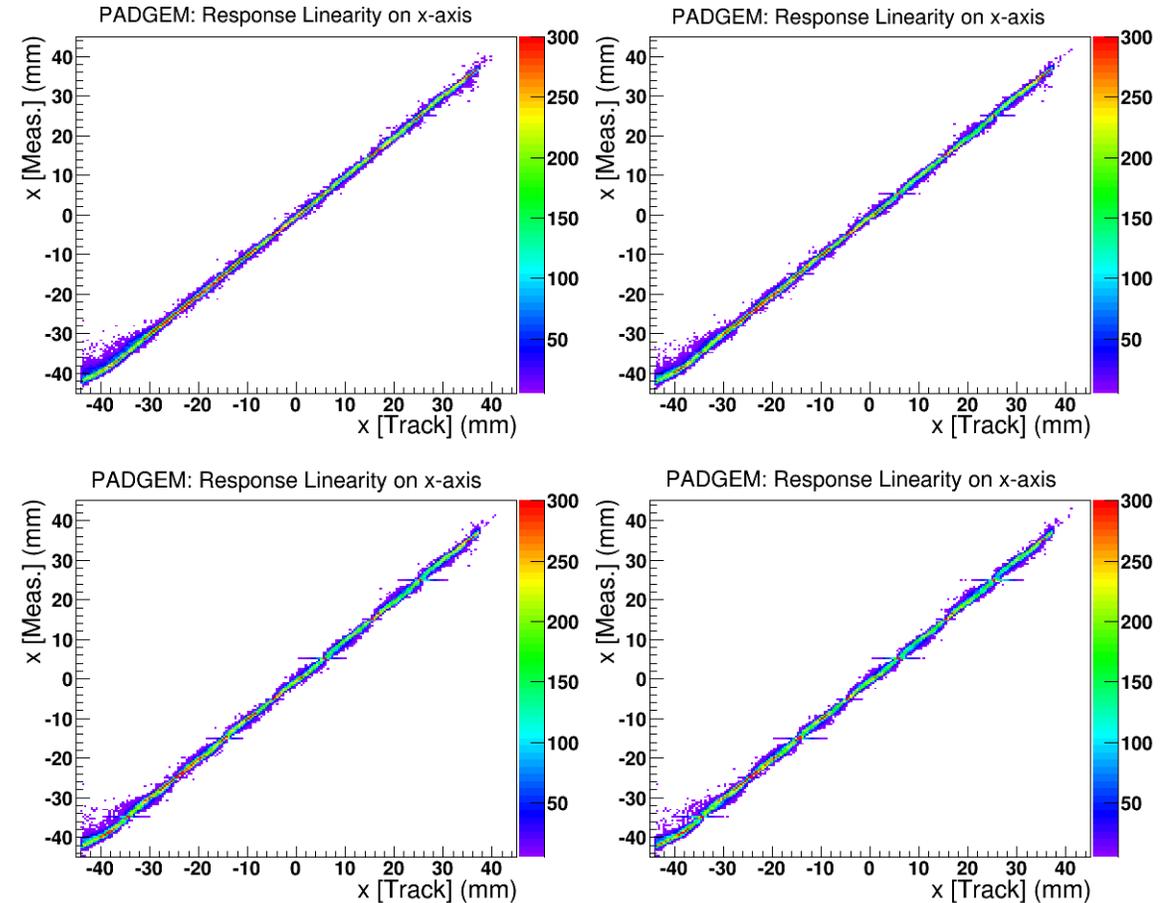


# Preliminary Results with JLab Test Beam Data

One week run with in parasitic setup in the electron beam side of with Hall D

Pair Spectrometer (PS).

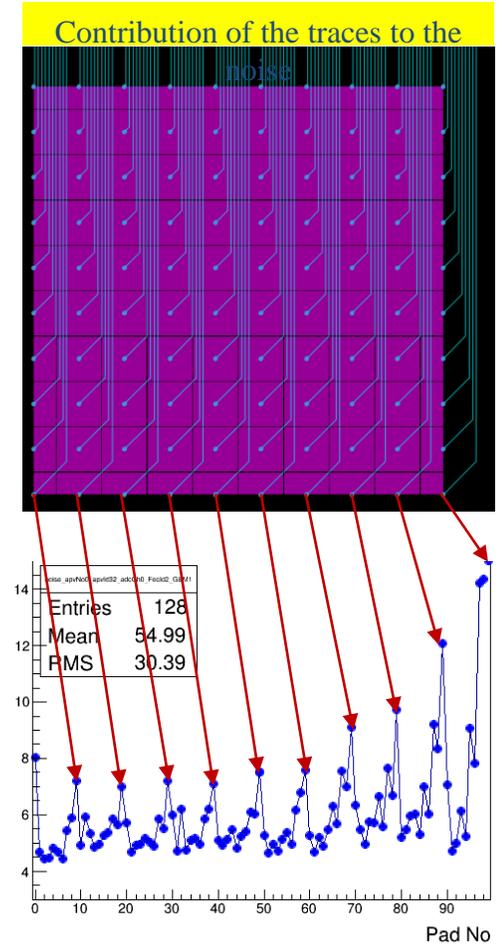
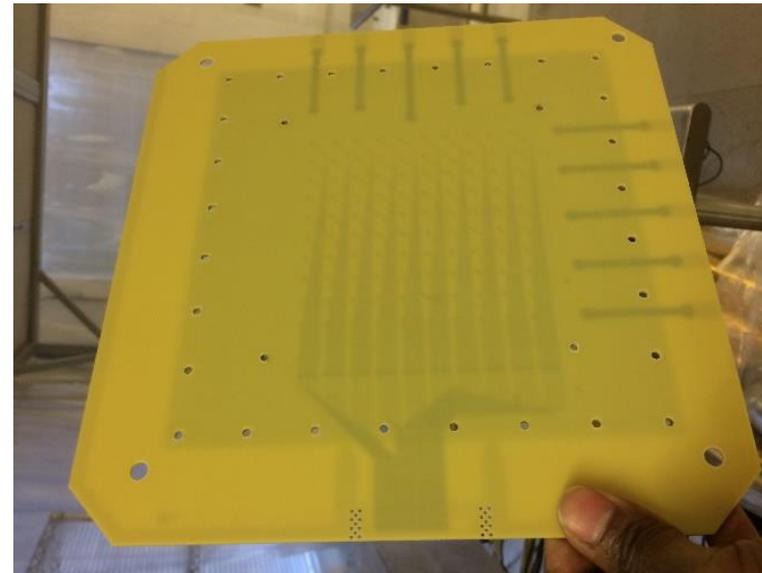
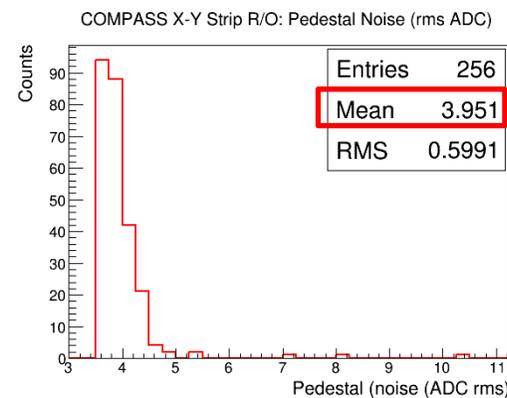
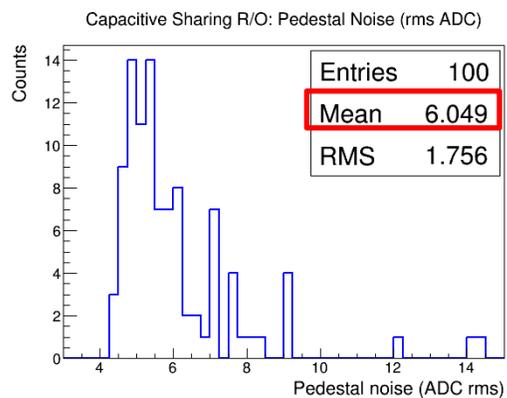
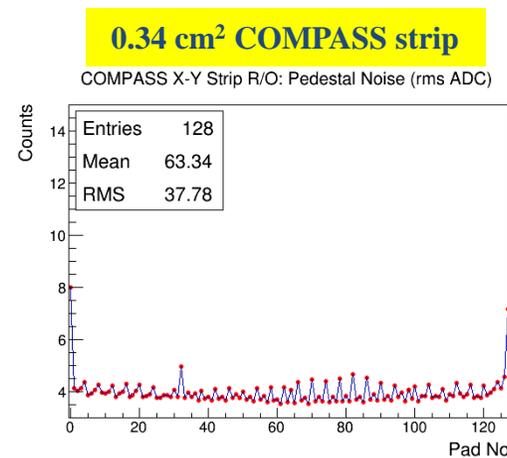
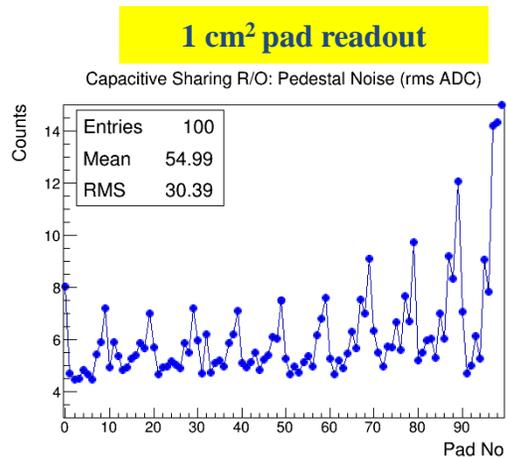
- ❑ Clean electron beam (3 to 6 GeV), incoming angle up to 8 degree
- ❑ Large Pad GEM + 3 small X-Y CERN standard triple-GEM for tracking
- ❑ APV25-SRS readout (DATE + AmoreSRS), trigger rate limited to 400Hz
- ❑ Large volume of data for HV scan and for spatial resolution studies



# First Prototype Tested at UVa & Preliminary Results

## Impact of the pad size on the pedestal noise

- ❑ We compare noise of APV2 connected to the pad board with typical noise performance of COMPASS 400  $\mu\text{m}$  X-Y strips
- ❑ Bottom strip of COMPASS readout is 340  $\mu\text{m}$  wide so the strip area is 0.34  $\text{cm}^2$  so the area of the pad is 3 times bigger
- ❑ But the average noise of the capacitive-sharing large-pad is just **1.5 times higher**

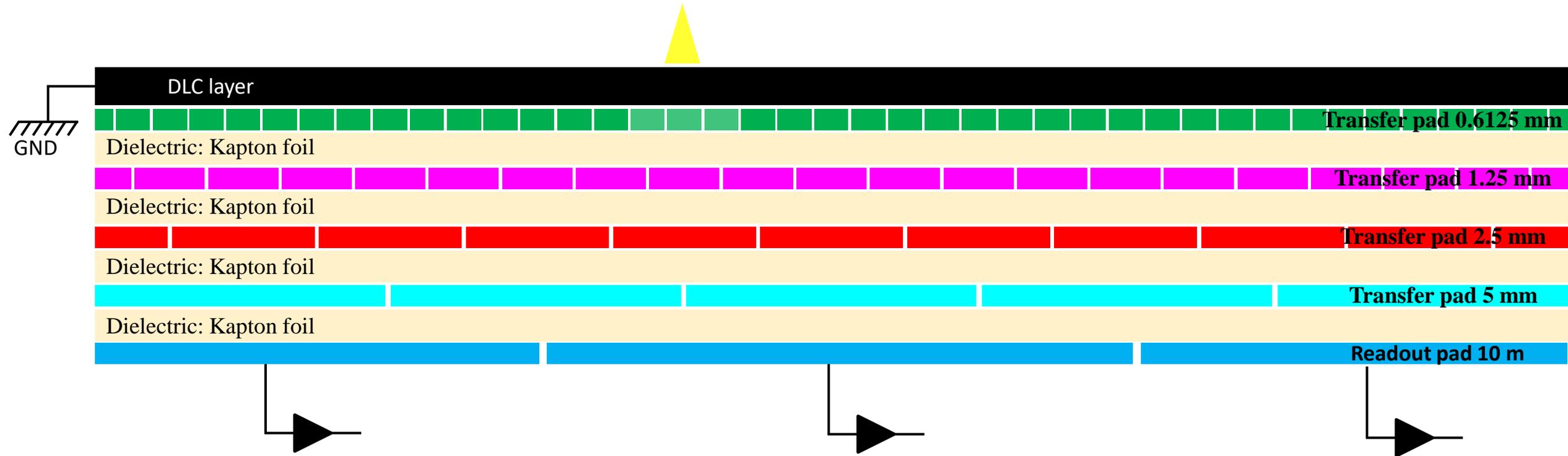


- ❑ The traces connecting the pad to the FE boards has a significant contribution to the noise
  - ⇒ Clear correlation between the pic and the length of the traces
- ❑ For this prototype, the traces are **200  $\mu\text{m}$  wide**
- ❑ Obvious improvement for next prototype: reduce the width to **50  $\mu\text{m}$**
- ❑ Reduce the length as much as possible and keep a relative equal length between traces

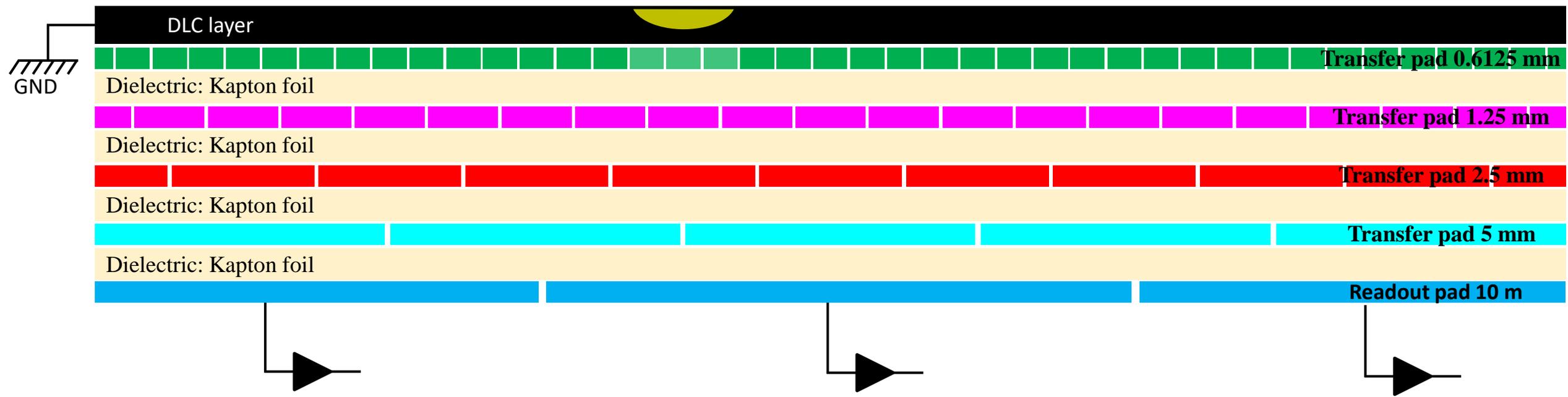
# Principle of Large Pads with Capacitive Sharing readout PCB

- ❑ The PCB is a vertical stack 50  $\mu\text{m}$  Kapton foils with 5  $\mu\text{m}$  (or less) Cu pads on top  $\Rightarrow$  The pad size doubles from a layer to the one underneath
- ❑ pad of layer[i] is arranged so that its center is **either aligned with the center of a pad or to the boundary between** 2 adjacent pads of layer[i+1].
- ❑ This pad arrangement ensured that the charges collected on 2 adjacent pads on layer[i] are always transferred to 2 adjacent pads of layer[i+1]  
 $\Rightarrow$  **Regardless of the pad size, at least 2 pads will always share the charges from charge cloud from the upper layer**
- ❑ The charges are transferred from one layer to the layer underneath through **capacitive coupling**
- ❑ The pads of the bottom layer (**readout layer**), are the only one connected to FE readout cards to read the signal out
- ❑ All other layers with floating pads are **transfer layers that** only participates in charge spreading through the **capacitive coupling**
- ❑ Spatial resolution **is de facto imposed in first order by the pad size of the top layer**, no matter the pad size of the bottom layer (readout layer)
- ❑ The number of FE readout channels **is imposed by the pad size of the bottom layer**, no matter the required spatial resolution  
 $\Rightarrow$  **High spatial resolution achievable with reduced number of readout channels**  $\Rightarrow$  10 cm  $\times$  10 cm triple-GEM with 1 cm  $\times$  1 cm pad readout requires only **100 pads** instead of **512 strips** with the COMPASS readout to achieve similar spatial resolution performance level  
 $\Rightarrow$  **High flexibility** with this type of readout  $\Rightarrow$  spatial resolution does not depend on the readout pad size
- ❑ DLC on top of the first pad layer is mostly to evacuate the charges from the amplification **but also** contribute to the initial charge spread

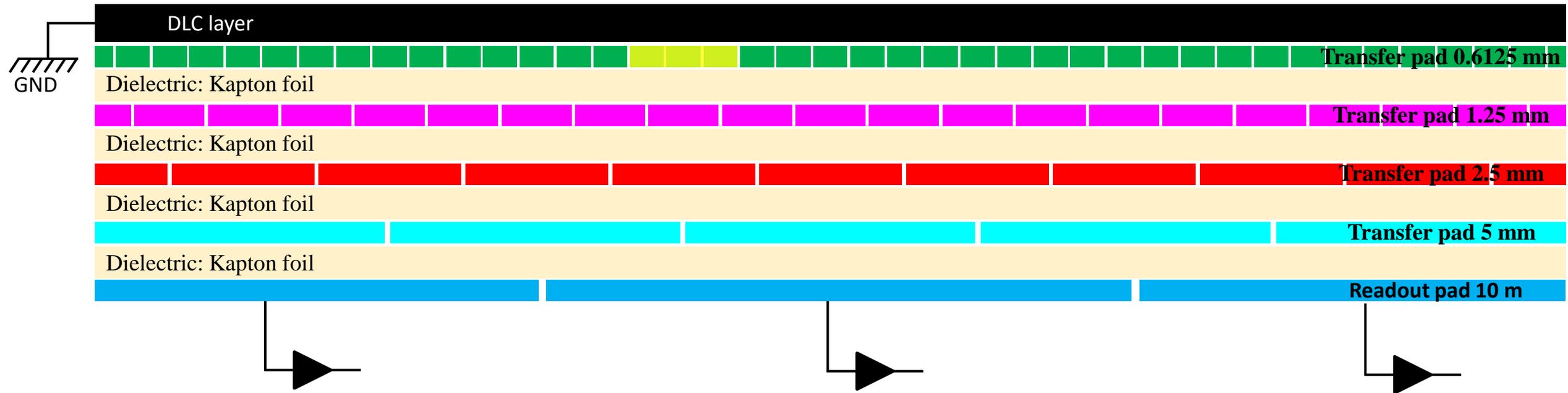
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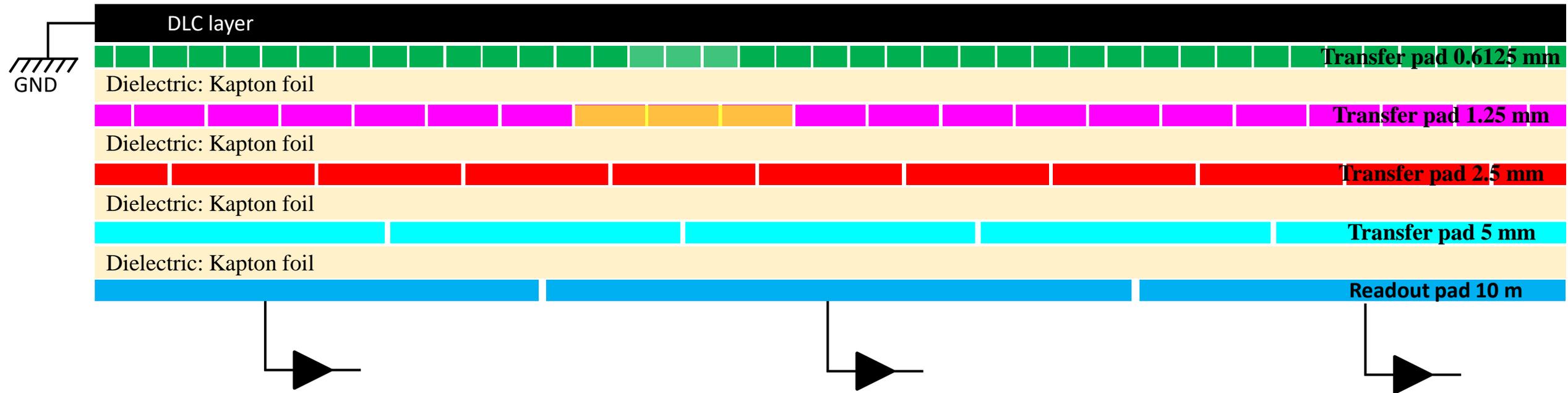
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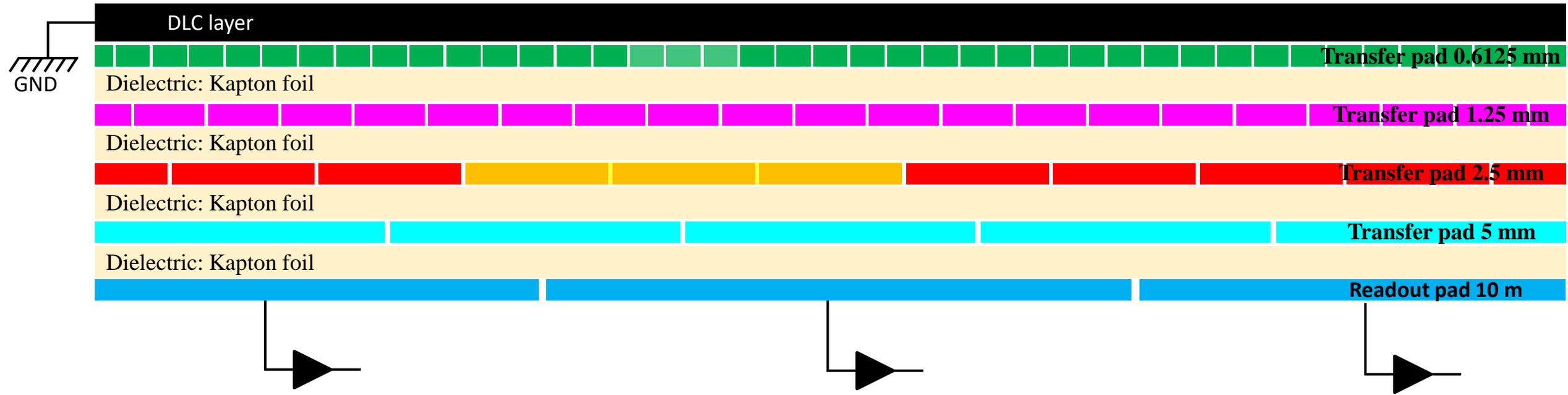
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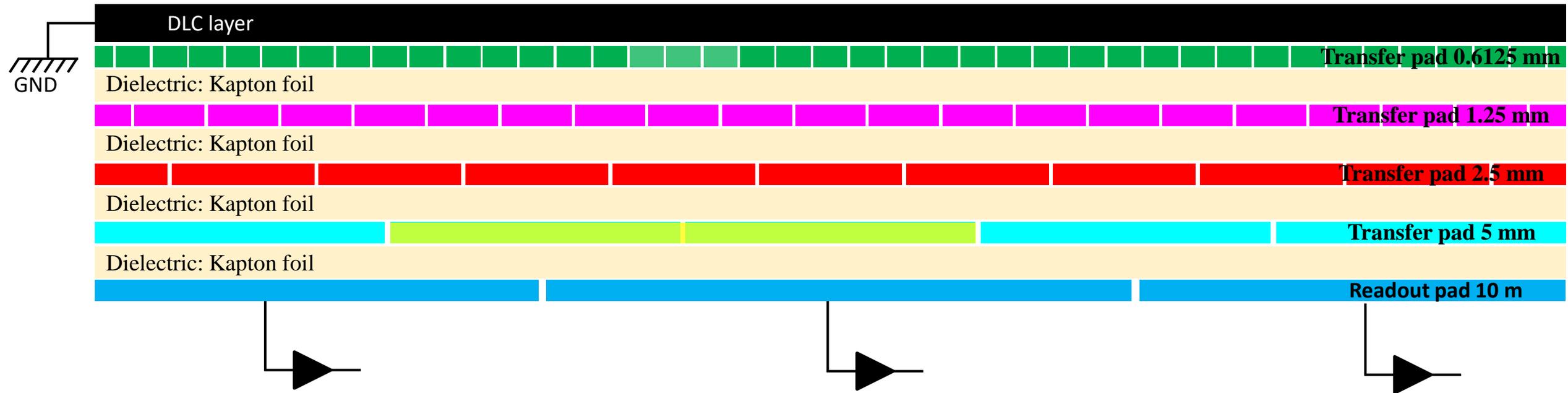
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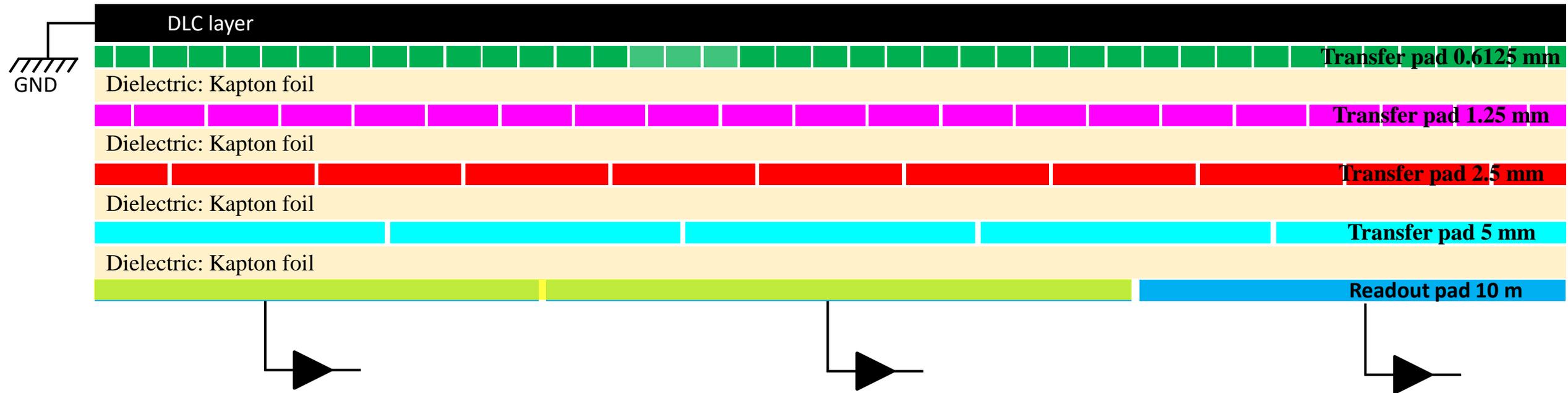
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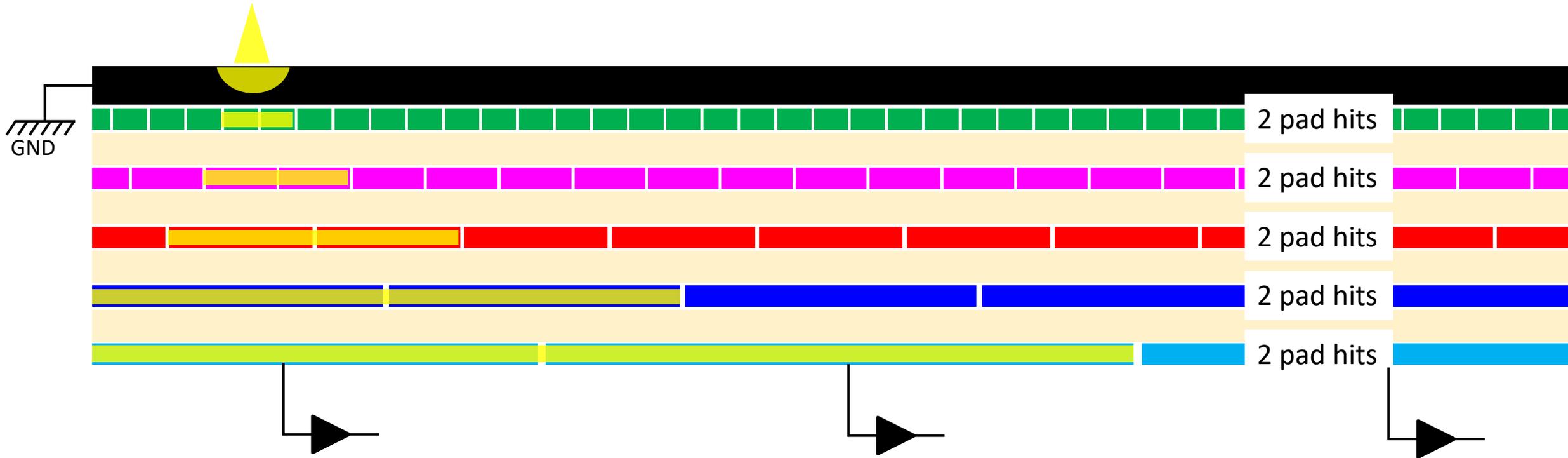
# Principle of Large Pads with Capacitive Sharing readout PCB



# Principle of Large Pads with Capacitive Sharing readout PCB



# Principle of large pads readout with high spatial resolution capabilities

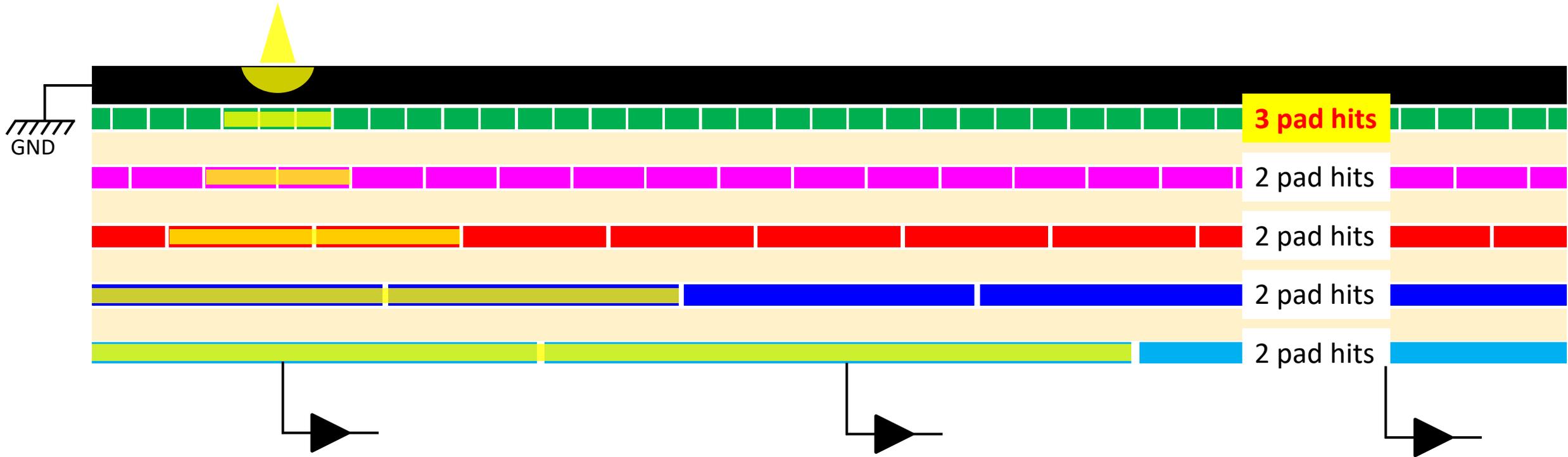


## Spatial resolution performances basically depends on how many pads from top layers have hits

- Typically, charges from a standard (3-2-2-2-) triple-GEM will hit on average 3 COMPASS X-Y (400  $\mu\text{m}$  pitch) strips,
- So with DLC layer contribution, top layer pad size of 0.6125  $\mu\text{m}$  will always have at least two pads with hit on average in each direction
  - ⇒ Meaning at least 4 pads (x and y direction) on average with hit on top layers ⇒ so expect an average number of pad on the readout layer  $> 4$

Illustration here in one direction only

# Principle of large pads readout with high spatial resolution capabilities

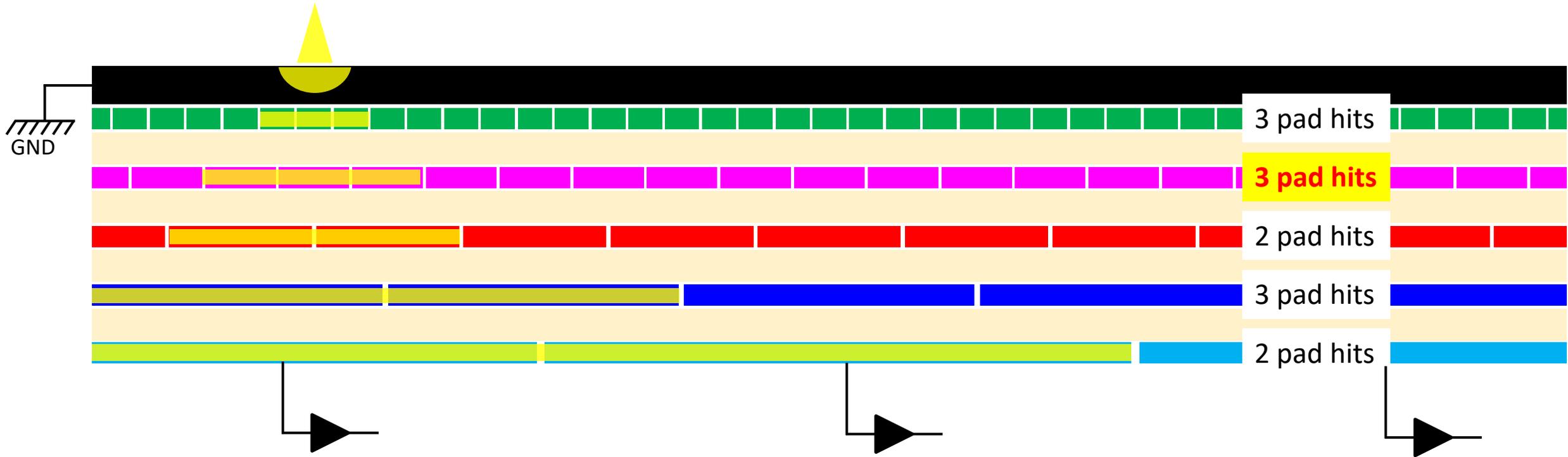


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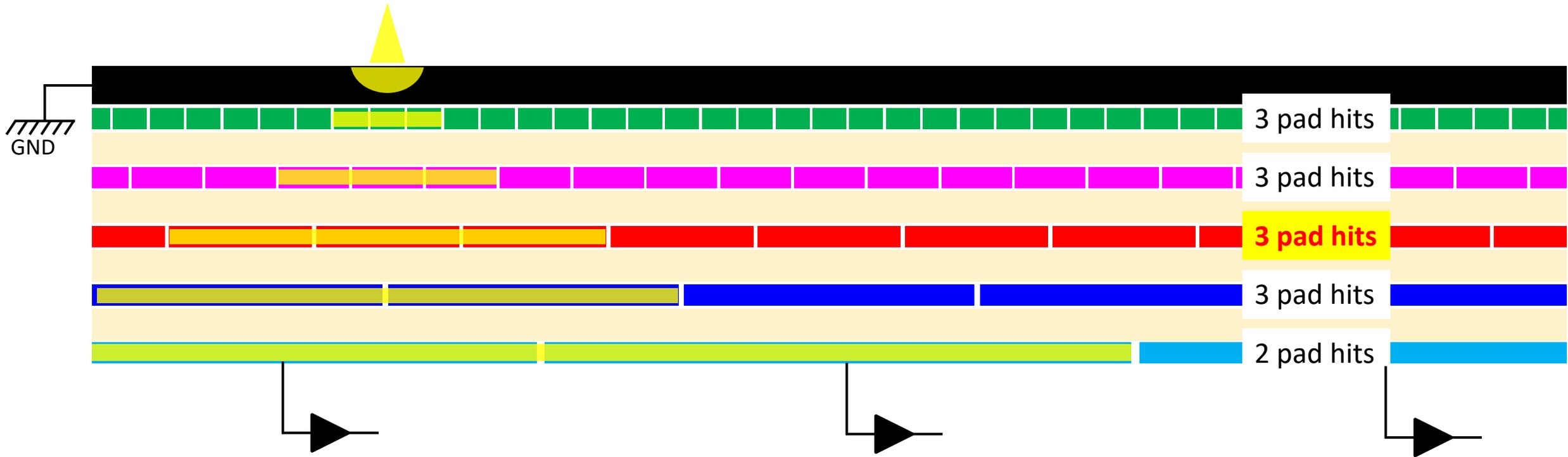


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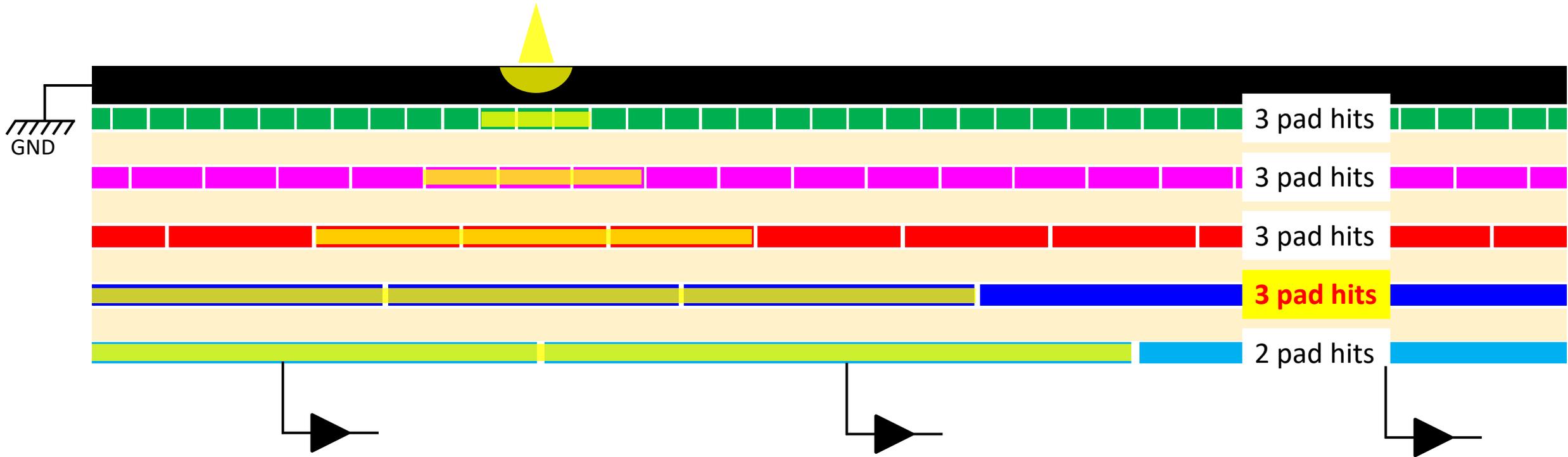


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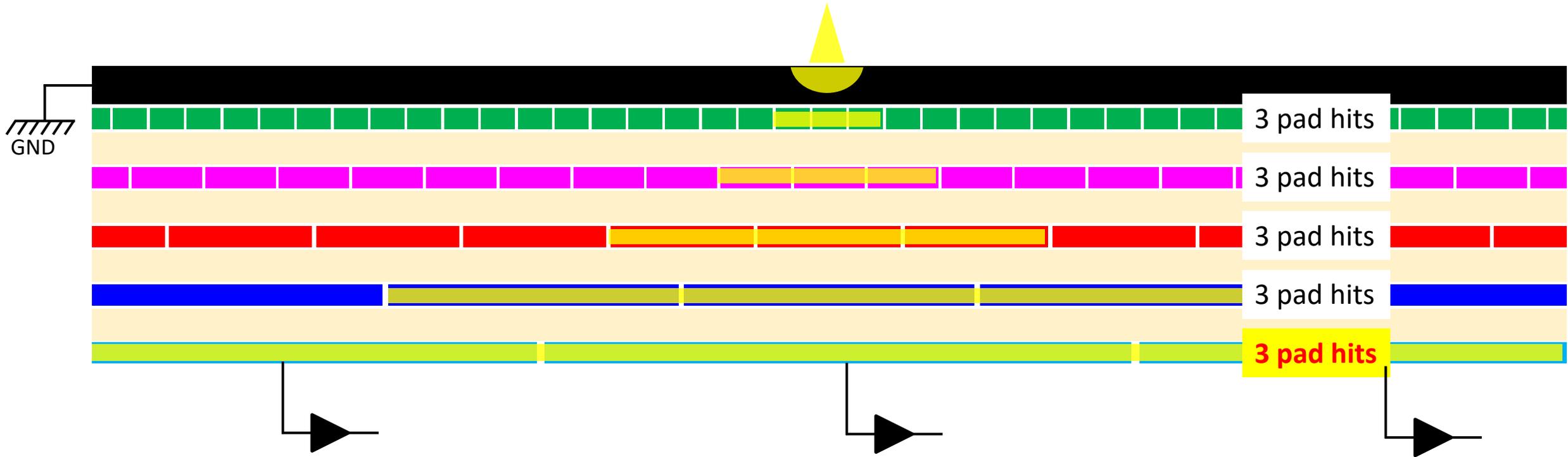


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